D2TO35

# Surface Mount Power Resistor Thick Film Technology 



DESIGN SUPPORT TOOLS click logo to get started $3 D$
Models
Available

## FEATURES

- AEC-Q200 qualified
- 35 W at $25^{\circ} \mathrm{C}$ case temperature
- Surface mounted resistor - TO-263 (D2PAK) style package
- Wide resistance range from $0.01 \Omega$ to $550 \mathrm{k} \Omega$
(P)

RoHS
COMPLIANT

DIMENSIONS in millimeters


## Notes

- For the assembly on board, we recommend the lead ( Pb )-free thermal profile as per J-STD-020C
- Power dissipation is 3.5 W at an ambient temperature of $25^{\circ} \mathrm{C}$ when mounted on a double sided copper board using FR4 HTG, $70 \mu \mathrm{~m}$ of copper, $39 \mathrm{~mm} \times 30 \mathrm{~mm} \times 1.6 \mathrm{~mm}$, with thermal vias


## STANDARD ELECTRICAL SPECIFICATIONS

| MODEL | SIZE | RESISTANCE <br> RANGE <br> $\boldsymbol{\Omega}$ | RATED POWER <br> $\boldsymbol{P}_{\mathbf{2 5}}{ }^{\circ} \mathbf{C}$ | LIMITING ELEMENT <br> VOLTAGE $\boldsymbol{U}_{\mathbf{L}}$ <br> $\mathbf{V}$ | TOLERANCE <br> $\mathbf{m}$ | TEMPERATURE <br> COEFFICIENT <br> $\mathbf{~ P p m} /{ }^{\circ} \mathbf{C}$ | CRITICAL <br> RESISTANCE <br> $\boldsymbol{\Omega}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| D2TO35 | TO-263 | 0.01 to 550 K | 35 | 500 | $1,2,5,10$ | $150,250,700,1100$ | 7.14 K |


| MECHANICAL SPECIFICATIONS |  |
| :--- | :---: |
| Mechanical Protection | Molded |
| Resistive Element | Thick film |
| Substrate | Alumina |
| Connections | Tinned copper |
| Weight | 2.2 g max. |

## ENVIRONMENTAL SPECIFICATIONS

| Temperature Range | $-55^{\circ} \mathrm{C}$ to $+175^{\circ} \mathrm{C}$ |
| :--- | :---: |
| Flammability | IEC $60695-11-5$ |
|  | 2 applications 30 s |
|  | separated by 60 s |

## TECHNICAL SPECIFICATIONS

| Power Rating and Thermal Resistance of the Component | 35 W at $25^{\circ} \mathrm{C}$ (case temperature) <br> $\mathrm{R}_{\mathrm{TH}(\mathrm{j}-\mathrm{c})}: 4.28^{\circ} \mathrm{C} / \mathrm{W}$ |
| :---: | :---: |
| Temperature Coefficient Standard | See Special Feature table $\pm 150 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Dielectric Strength IEC 60115-1 | $2000 \mathrm{~V}_{\text {RMs }}-1$ min - 10 mA max. (between terminals and board) |
| Insulation Resistance | $\geq 10^{6} \mathrm{M} \Omega$ |
| Inductance | $\leq 0.1 \mu \mathrm{H}$ |


| DIMENSIONS |  |
| :--- | :---: |
| Standard Package | TO-263 style <br> (D2PAK) |

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| SPECIAL FEATURES |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Resistance Values | $\geq 0.010$ | $\geq 0.045$ | $\geq 0.1$ | $\geq 0.5$ |  |
| Tolerances | $\pm 10 \%$ at $\pm 10 \%$ |  |  |  |  |
| Requirement Temperature Coefficient (TCR) <br> $\left(-55{ }^{\circ}{ }^{\circ} \mathbf{C}+1500^{\circ} \mathrm{C}\right)$ <br> IEC $60115-1$ | $\pm 1100 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $\pm 700 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $\pm 250 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | $\pm 150 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |  |


| PERFORMANCE |  |  |
| :---: | :---: | :---: |
| TESTS | CONDITIONS | REQUIREMENTS |
| Momentary Overload | IEC 60115-1 §4.13 <br> 1.7 $\operatorname{Pr} 5 \mathrm{~s}$ for $R<2 \Omega$ <br> 1.4 $\operatorname{Pr} 5 \mathrm{~s}$ for $R \geq 2 \Omega$ US < 1.5 UL | $\pm(0.25 \%+0.005 \Omega)$ |
| Load Life | $\begin{gathered} \text { IEC } 60115-1 \\ 1000 \mathrm{~h}, 90 / 30 \mathrm{Pr} \text { at }+25^{\circ} \mathrm{C} \end{gathered}$ | $\pm(1 \%+0.005 \Omega)$ |
| High Temperature Exposure | AEC-Q200 REV D conditions: MIL-STD-202 method 108 $1000 \mathrm{~h},+175^{\circ} \mathrm{C}$, unpowered | $\pm(0.25 \%+0.005 \Omega)$ |
| Temperature Cycling | Pre-conditioning 3 reflows according JESTD020D <br> IEC 60068-2-14 test Na 1000 cycles, $-55^{\circ} \mathrm{C},+175^{\circ} \mathrm{C}$ Dwell time - 15 min | $\pm(0.5 \%+0.005 \Omega)$ |
| Moisture Resistance | AEC-Q200 REV D conditions: MIL-STD-202 method 106 10 cycles, 24 h , unpowered | $\pm(0.5 \%+0.005 \Omega)$ |
| Biased Humidity | AEC-Q200 REV D conditions: MIL-STD-202 method 103 $1000 \mathrm{~h}, 85^{\circ} \mathrm{C}, 85 \% \mathrm{RH}$ | $\pm(1 \%+0.005 \Omega)$ |
| Operational Life | AEC-Q200 REV D conditions: Pre-conditioning 3 reflows according JESTDO20D <br> MIL-STD-202 method 108 <br> $2000 \mathrm{~h}, 90 / 30$, powered, $+125^{\circ} \mathrm{C}$ | $\pm(1 \%+0.005 \Omega)$ |
| ESD Human Body Model | AEC-Q200 REV D conditions: $\begin{gathered} \text { AEC-Q200-002 } \\ 25 \mathrm{kV}_{\mathrm{AD}} \\ \hline \end{gathered}$ | $\pm(0.5$ \% + $0.005 \Omega$ ) |
| Vibration | AEC-Q200 REV D conditions: MIL-STD-202 method 204 5 g's for $20 \mathrm{~min}, 12$ cycles test from 10 Hz to 2000 Hz | $\pm(0.5 \%+0.005 \Omega)$ |
| Mechanical Shock | AEC-Q200 REV D conditions: MIL-STD-202 method 213 100 g 's, $6 \mathrm{~ms}, 3.75 \mathrm{~m} / \mathrm{s}$ 3 shocks/direction | $\pm(0.5 \%+0.005 \Omega)$ |
| Board Flex | AEC-Q200 REV D conditions: <br> AEC-Q200-005 <br> bending $2 \mathrm{~mm}, 60 \mathrm{~s}$ | $\pm(0.25 \%+0.01 \Omega)$ |
| Terminal Strength | AEC-Q200 REV D conditions: AEC-Q200-006 $1.8 \mathrm{kgf}, 60 \mathrm{~s}$ | $\pm(0.25 \%+0.01 \Omega)$ |


| ASSEMBLY SPECIFICATIONS |  |  |  |
| :--- | :---: | :---: | :---: |
| For the assembly on board, we recommend the lead (Pb)-free thermal profile as per J-STD-020C |  |  |  |
| TESTS | CONDITIONS | REQUIREMENTS |  |
| Resistance to Soldering Heat | IEC $60115-1$ <br> IEC $60068-2-58$ <br> Solder bath method: $2700^{\circ} \mathrm{C} / 10 \mathrm{~s}$ | $\pm(0.5 \%+0.005 \Omega)$ |  |
| Moisture Sensitivity Level (MSL) | IPC/JEDEC® $\mathrm{J}-\mathrm{STD}-020 \mathrm{C}$ <br> $85^{\circ} \mathrm{C} / 85 \% \mathrm{RH} / 168 \mathrm{~h}$ | Level: 1 <br> + pass requirements of TCR <br> overload and dielectric strength after MSL |  |

## CHOICE OF THE BOARD

The user must choose the board according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed $175^{\circ} \mathrm{C}$. The dissipated power is simply calculated by the following ratio:

$$
P=\frac{\Delta T}{R_{T H(j-c)}+R_{T H(c-h)}+R_{T H(h-a)}}
$$

## P: $\quad$ Expressed in W

$\Delta \mathrm{T}$ : Difference between maximum working temperature and room temperature or fluid cooling temperature
$R_{T H}(j-c)$ : Thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal resistance of the component: $4.28^{\circ} \mathrm{C} / \mathrm{W}$.
$\mathrm{R}_{\mathrm{TH}(\mathrm{c}-\mathrm{h})}$ : Thermal resistance value measured between outer side of the resistor and upper side of the board. This is the thermal resistance of the solder layer.
$R_{T H}(h-a)$ : Thermal resistance of the board.

## Example:

$\mathrm{R}_{\mathrm{TH}(\mathrm{c}-\mathrm{h})}+\mathrm{R}_{\mathrm{TH}(\mathrm{h}-\mathrm{a})}$ for D2TO35 power rating 3.5 W at ambient temperature $+25^{\circ} \mathrm{C}$.
Thermal resistance $R_{T H}(j-c): 4.28^{\circ} \mathrm{C} / \mathrm{W}$
Considering equation ${ }^{(1)}$ we have:

$$
\begin{aligned}
& \Delta \mathrm{T}=175{ }^{\circ} \mathrm{C}-25^{\circ} \mathrm{C}=150^{\circ} \mathrm{C} \\
& R_{\text {TH }(j-c)}+R_{T H}(\mathrm{c}-\mathrm{h})+\mathrm{R}_{\mathrm{TH}(\mathrm{~h}-\mathrm{a})}=\Delta \mathrm{T} / \mathrm{P}=150 / 3.5=42.8^{\circ} \mathrm{C} / \mathrm{W} \\
& R_{\text {TH }(\mathrm{c}-\mathrm{h})}+\mathrm{R}_{\text {TH }(\mathrm{h}-\mathrm{a})}=42.8^{\circ} \mathrm{C} / \mathrm{W}-4.28^{\circ} \mathrm{C} / \mathrm{W}=38.52^{\circ} \mathrm{C} / \mathrm{W}
\end{aligned}
$$

## Single Pulse:

These informations are for a single pulse on a cold resistor at $25^{\circ} \mathrm{C}$ (not already used for a dissipation) and for pulses of 100 ms maximum duration.

The formula used to calculate $E$ is:

$$
E=P \times t=\frac{U^{2}}{R} \times t
$$

with:
$E(J):$ Pulse energy
$P(\mathrm{~W})$ : Pulse power
$t$ (s): Pulse duration
U (V): Pulse voltage
$R(\mathrm{~W})$ : Resistor
The energy calculated must be less: than that allowed by the graph.

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## OVERLOADS

In any case the applied voltage must be lower than the maximum overload voltage of 750 V . The values indicated on the graph below are applicable to resistors in air or mounted onto a board.

## ENERGY CURVE



## POWER CURVE



## POWER RATING

The temperature of the case should be maintained within the limits specified.


## PACKAGING

- Reel
- Tube
- Tape dimensions $(\mathrm{mm})$ for reel:



## MARKING

Model, style, resistance value (in $\Omega$ ), tolerance (in \%), manufacturing date, Vishay Sfernice trademark

D2TO35

| ORDERING INFORMATION |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| D2TO | 35 | C | $100 \mathrm{k} \Omega$ | $\pm 1$ \% | XXX | e3 |
| MODEL | STYLE | CONNECTIONS | RESISTANCE VALUE | TOLERANCE | CUSTOM DESIGN | LEAD (Pb)-FREE |
|  |  |  |  | $\begin{aligned} \mathrm{F} & = \pm 1 \% \\ \mathrm{G} & = \pm 2 \% \\ \mathrm{~J} & = \pm 5 \% \\ \mathrm{~K} & = \pm 10 \% \end{aligned}$ | Optional on request: shape, etc. |  |

## SAP PART NUMBERING GUIDELINES



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| D2TO035C5R000FTE3 D2TO035CR0500FTE3 D2TO035C10000FTE3 D2TO035C100R0FTE3 |  |  |  |
| D2TO035C10R00FTE3 D2TO035C15R00FTE3 D2TO035C1R000FTE3 D2TO035C22R00FTE3 |  |  |  |
| D2TO035C2R200FTE3 | D2TO035C47R00FTE3 | D2TO035CR0100FTE3 | D2TO035CR0150FTE3 |
| D2TO035CR0220FTE3 | D2TO035CR0680FTE3 | D2TO035CR1000FTE3 | D2TO035CR4700FTE3 |
| D2TO035C150R0JTE3 D2TO035C33000JTE3 D2TO035CR0100GTE3 D2TO035C47R00KTE3 |  |  |  |
| D2TO035CR0150JRE3 D2TO035C2R700KRE3 D2TO035CR0150FRE3 D2TO035C1R000GRE3 |  |  |  |
| D2TO035C200R0KTE3 D2TO035C33000FTE3 D2TO035C3R300FRE3 D2TO035C44000JTE3 |  |  |  |
| D2TO035C11000KTE3 D2TO035C10001FRE3 D2TO035C12000JTE3 D2TO035C499R0FTE3 |  |  |  |
| D2TO035C1R700FRE3 D2TO035CR4700FRE3 |  |  |  |

